Claims

- [c1] 1. A method for generating a process aid on a wafer, the method comprising the steps of:
 - entering a process technology and a process aid type to be built into a program;
 - reading technology design rules and process aid parameters for the process aid type into the program; accessing a process aid instruction file to attain instructions for building the process aid; and building the process aid in on the wafer using the instructions based on the technology design rules and the process aid parameters.
- [c2] 2. The method of claim 1, wherein the building step includes building the process aid in one of a kerf and a sacrificial die on the wafer.
- [c3] 3. The method of claim 1, wherein the instructions include scheme code.
- [c4] 4. The method of claim 1, further comprising the step of documenting the process aid.
- [05] 5. The method of claim 4, wherein the documentation includes process aid location.

- [c6] 6. The method of claim 1, further comprising at least one of the steps of verifying the process aid against production data and testing the process aid.
- [c7] 7. The method of claim 1, further comprising the step of rerunning the step of building.
- [08] 8. A system for generating a process aid on a wafer, the system comprising:

means for entering a process technology and a process aid type into a program;

means for reading technology design rules and process aid parameters for the process aid into the program;

means for accessing a process aid instruction file to attain instructions for building the process aid; and means for building the process aid on the wafer using the instructions based on the technology design rules and process aid parameters.

- [09] 9. The system of claim 8, wherein the process aid is one of an electrical device and an optical device.
- [c10] 10. The system of claim 8, wherein the instructions include scheme code.
- [c11] 11. The system of claim 8, further comprising means for

documenting the process aid.

- [c12] 12. The system of claim 11, wherein the documentation includes process aid location.
- [c13] 13. The system of claim 8, further comprising means for verifying the process aid against production data.
- [c14] 14. The system of claim 8, further comprising means for testing the process aid.
- [c15] 15. A computer program product comprising a computer useable medium having computer readable program code embodied therein for generating a process aid on a wafer, the program product comprising:

program code configured to allow entering a process technology and the process aid type; program code configured to read technology design rules and process aid parameters for the process aid; program code configured to access a process aid instruction file to attain instructions for building the process aid; and program code configured to build the process aid on the wafer using the instructions based on the technology design rules and process aid parameters.

[c16] 16. The program product of claim 15, wherein the process aid is one of an electrical device and an optical de-

vice.

- [c17] 17. The program product of claim 15, wherein the instructions include scheme code.
- [c18] 18. The program product of claim 15, further comprising program code configured to document the process aid.
- [c19] 19. The program product of claim 15, further comprising program code configured to verify the process aid against production data.
- [c20] 20. The program product of claim 15, further comprising program code configured to test the process aid.